



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	V _{(BR)DSS}	R _{DS(ON) max}	I _{D MAX} T _A = +25°C
		$29m\Omega @ V_{GS} = 4.5V$	5.6A
Q1	12V	$34m\Omega$ @ $V_{GS} = 2.5V$	5.1A
N-Channel		$44m\Omega$ @ $V_{GS} = 1.8V$	4.5A
		$65m\Omega @ V_{GS} = 1.5V$	3.7A
		$61m\Omega @ V_{GS} = -4.5V$	-3.8A
Q2	-12V	$81m\Omega @ V_{GS} = -2.5V$	-3.3A
P-Channel		115mΩ @ V _{GS} = -1.8V	-2.8A
		210mΩ @ V _{GS} = -1.5V	-2.3A

Description

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Load Switch
- Power Management Functions
- Portable Power Adaptors

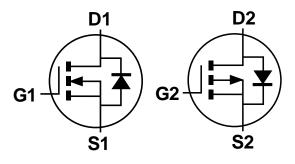
U-DFN2020-6 S2 G2 D1 D1 Bottom View

Features

- Low On-Resistance
- Low Input Capacitance
- Low Profile, 0.6mm Max Height
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202. Method 208
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)



N-CHANNEL MOSFET P-CHANNEL MOSFET Internal Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
DMC1029UFDB -7	U-DFN2020-6	3000/Tape & Reel
DMC1029UFDB -13	U-DFN2020-6	10000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html

Marking Information



2D = Product Type Marking Code YM = Date Code Marking Y = Year (ex: B = 2014) M = Month (ex: 9 = September)

Date Code Key

Year	201	4	2015		2016	20	17	2018		2019	2	2020
Code	В		С		D			F		G		Н
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Characteristic	Symbol	Q1 N-CHANNEL	Q2 P-CHANNEL	Units		
Drain-Source Voltage			V_{DSS}	12	-12	V
Gate-Source Voltage	V_{GSS}	±8	±8	V		
Continuous Drain Current (Note EVV 4.5V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	5.6 4.4	-3.8 -3.0	А
Continuous Drain Current (Note 5) V _{GS} = 4.5V	t < 5s	$T_A = +25$ °C $T_A = +70$ °C	I _D	7.2 5.8	-5.0 -4.0	А
Maximum Continuous Body Diode Forward Curre	ent (Note 5)		Is	1	-1	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle =	I _{DM}	20	-15	Α		
Avalanche Current (L = 0.1mH)	I _{AS}	15	-12	А		
Avalanche Energy (L = 0.1mH)			E _{AS}	12	8	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Units	
Total Power Dissipation (Note 5)	Steady State	0	1.4	W	
Total Fower Dissipation (Note 5)	t < 5s	P_{D}	2.2		
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	91		
Thermal Resistance, Junction to Ambient (Note 5)	t < 5s	$R_{ heta JA}$	55	°C/W	
Thermal Resistance, Junction to Case		$R_{ heta JC}$	20		
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +150	°C	

Note: 5. Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. Copper, single sided.



Electrical Characteristics Q1 N-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 6)								
Drain-Source Breakdown Voltage	BV _{DSS}	12	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$		
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	1.0	μΑ	$V_{DS} = 12V, V_{GS} = 0V$		
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 8V$, $V_{DS} = 0V$		
ON CHARACTERISTICS (Note 6)								
Gate Threshold Voltage	V _{GS(TH)}	0.4	_	1	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		
			17	29		$V_{GS} = 4.5V, I_D = 5A$		
Static Drain-Source On-Resistance	R _{DS(ON)}	_	20	34	mΩ	$V_{GS} = 2.5V, I_D = 4.6A$		
Static Drain-Source On-Resistance		_	24	44		$V_{GS} = 1.8V, I_D = 4.1A$		
		_	30	65		$V_{GS} = 1.5V, I_D = 2A$		
Diode Forward Voltage	V_{SD}	_	0.6	1.2	V	$V_{GS} = 0V, I_{S} = 1A$		
DYNAMIC CHARACTERISTICS (Note 7)								
Input Capacitance	C _{iss}		914	_	рF	.,		
Output Capacitance	Coss		132	_	pF	$V_{DS} = 6V, V_{GS} = 0V,$ - f = 1.0MHz		
Reverse Transfer Capacitance	C _{rss}	_	119	_	pF	1 = 1.0WI IZ		
Gate Resistance	R_g	_	1.26	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$		
Total Gate Charge (V _{GS} = 4.5V)		_	10.5	_	nC			
Total Gate Charge (V _{GS} = 8V)	Qg	_	19.6	_	nC],, O,, I, O, EA		
Gate-Source Charge	Qgs	_	1.2	_	nC	$V_{DS} = 6V, I_{D} = 6.5A$		
Gate-Drain Charge	Q_{gd}		1.6	_	nC	1		
Turn-On Delay Time	t _{D(ON)}	_	5.0	_	ns			
Turn-On Rise Time	t _R	_	10.5	_	ns	$V_{DD} = 6V, V_{GS} = 4.5V,$		
Turn-Off Delay Time	t _{D(OFF)}		16.6	_	ns	$R_L = 1.2\Omega$, $R_G = 1\Omega$		
Turn-Off Fall Time	t _F	_	4.1	_	ns			

Electrical Characteristics Q2 P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

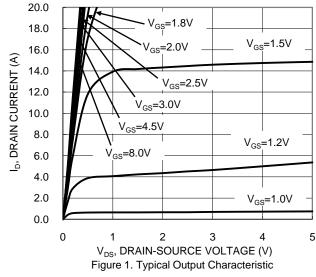
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BV _{DSS}	-12	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	-1.0	μΑ	V _{DS} = -12V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)						·	
Gate Threshold Voltage	$V_{GS(TH)}$	-0.4	_	-1	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
		_	37	61		$V_{GS} = -4.5V, I_D = -3.6A$	
Static Drain-Source On-Resistance		_	47	81	mΩ	$V_{GS} = -2.5V, I_{D} = -3.2A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	63	115	m22	V _{GS} = -1.8V, I _D = -1A	
			90	210		V _{GS} = -1.5V, I _D = -1A	
Diode Forward Voltage	V _{SD}	_	-0.65	-1.2	V	V _{GS} = 0V, I _S = -1A	
DYNAMIC CHARACTERISTICS (Note 7)			•	•	•	•	
Input Capacitance	C _{iss}	-	915	_	pF	.,	
Output Capacitance	Coss	_	225	_	pF	$V_{DS} = -6V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	183	_	pF	T = 1.0WHZ	
Gate Resistance	Rg	_	56.9	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = -4.5V)	0	_	10.7	_	nC		
Total Gate Charge (V _{GS} = -8V)	Qg	_	17.9	_	nC],, a,,	
Gate-Source Charge	Q _{as}		1.7	_	nC	$V_{DS} = -6V, I_{D} = -4.3A$	
Gate-Drain Charge	Q_{gd}	_	3.0	_	nC	1	
Turn-On Delay Time	t _{D(ON)}		5.7	_	ns		
Turn-On Rise Time	t _R		11.5	_	ns	$V_{DD} = -6V, V_{GS} = -4.5V,$	
Turn-Off Delay Time	t _{D(OFF)}		27.8	_	ns	$R_L = 1.6\Omega$, $R_G = 1\Omega$	
Turn-Off Fall Time	t _F		26.4	_	ns	7	

Notes: 6. Short duration pulse test used to minimize self-heating effect.

7. Guaranteed by design. Not subject to product testing.



Typical Characteristics - N-CHANNEL



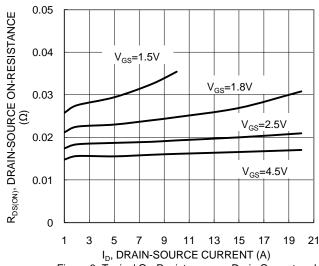


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

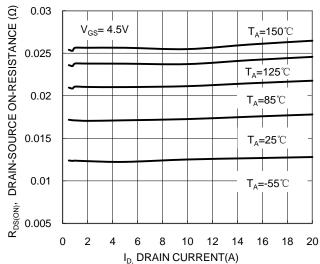
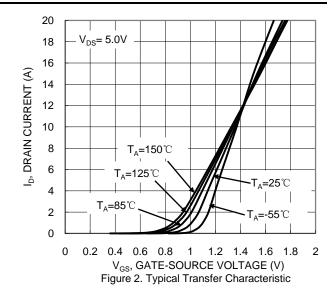
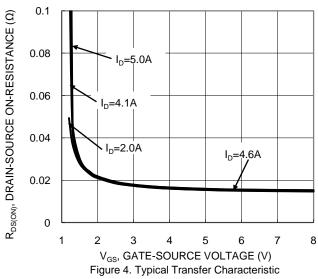
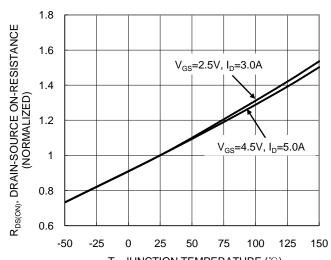


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





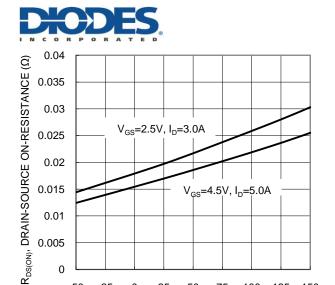


T_J, JUNCTION TEMPERATURE (${}^{\circlearrowright}$) Figure 6. On-Resistance Variation with Temperature

0

-50

-25



T₁ JUNCTION TEMPERATURE (°C) Figure 7. On-Resistance Variation with Temperature

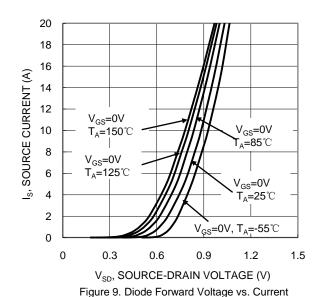
50

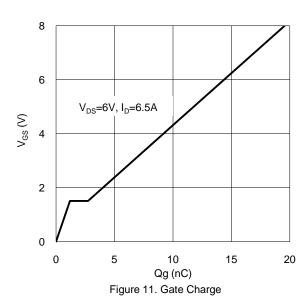
75

100 125

150

25





DMC1029UFDB

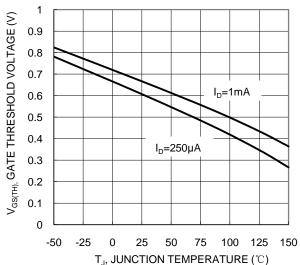


Figure 8. Gate Threshold Variation vs. Junction Temperature

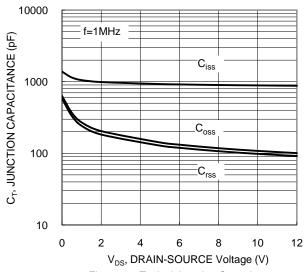
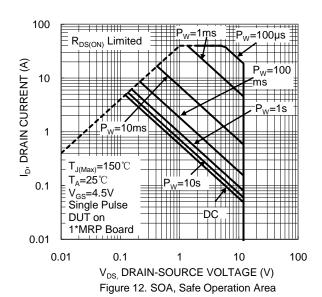
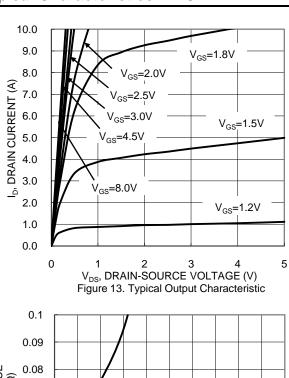


Figure 10. Typical Junction Capacitance





Typical Characteristics - P-CHANNEL



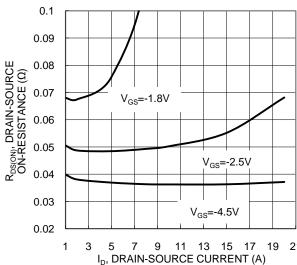


Figure 15. Typical On-Resistance vs Drain Current and Gate Voltage

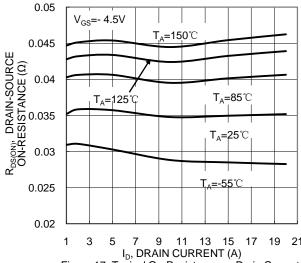
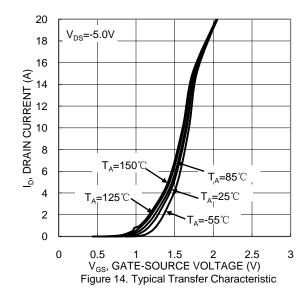
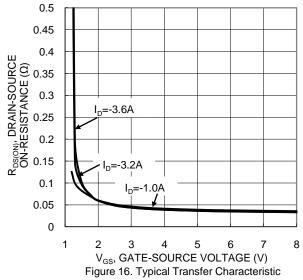
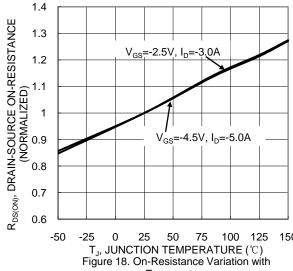


Figure 17. Typical On-Resistance vs Drain Current and Temperature

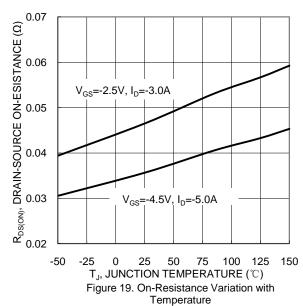


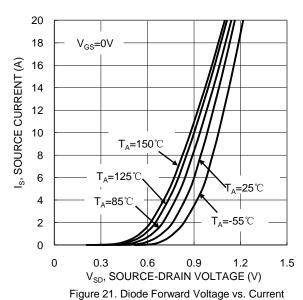


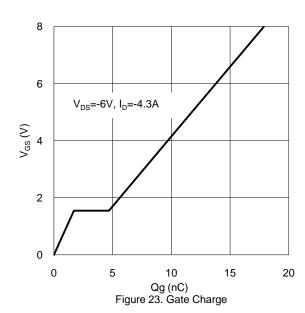


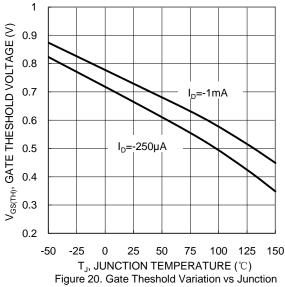
Temperature



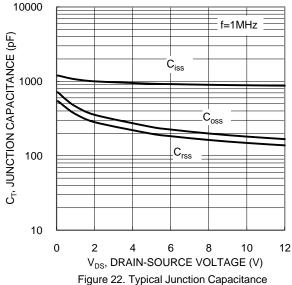


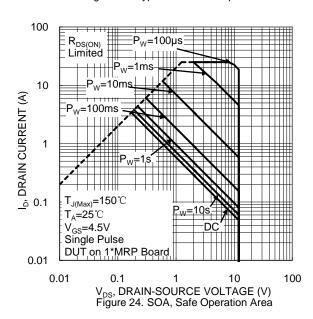




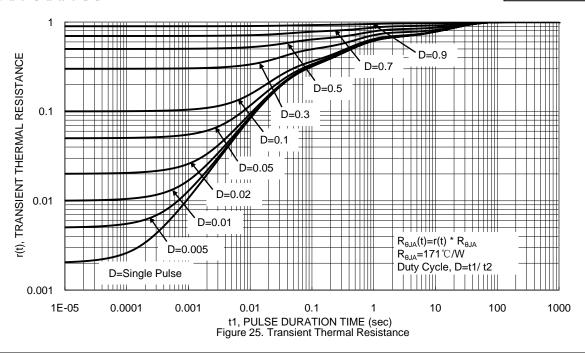


Temperature



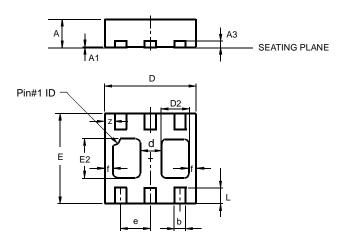






Package Outline Dimensions

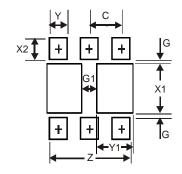
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



U-DFN2020-6								
Type B								
Dim	Min	Max	Тур					
Α	0.545	0.605	0.575					
A1	0	0.05	0.02					
A3			0.13					
b	0.20	0.30	0.25					
D	1.95	2.075	2.00					
d	_	_	0.45					
D2	0.50	0.70	0.60					
е	_	_	0.65					
Е	1.95	2.075	2.00					
E2	0.90	1.10	1.00					
f		_	0.15					
L	0.25	0.35	0.30					
z	_	_	0.225					
All	Dimens	ions in	mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	1.67
G	0.20
G1	0.40
X1	1.0
X2	0.45
Υ	0.37
Y1	0.70
С	0.65



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